TECHNICAL DATA SHEET



REL22 HIGH-RELIABILITY LEAD-FREE SOLDER ALLOY

FEATURES

- Enhanced Durability for Use in Extremely Harsh Environments
- Reliability Equal to Sn/Ag/Bi/Sb/Ni/Cu Alloys with Wider Assembly Process Window
- Mitigates Tin Whisker Formation
- Oreep Rates Lower Than SAC Alloys
- High Reliability / High Strength
- Improved Thermal Cycling Performance
- Improved Wetting Versus All Low/No-Silver Alloys
- For use in Lead-Free Process Only
- Occupies with IPC J-STD-006

DESCRIPTION

AIM's REL22TM alloy is comprised of tin, bismuth, silver, copper, antimony, nickel and trace amounts of elemental grain structure refiners. The alloy provides significantly improved durability for use in applications where thermal shock, vibration and high g-forces are a concern. REL22 is the solution when SAC alloys are incapable of surviving in harsh environments, such as automotive, aerospace and geographical exploration equipment.

AVAILABILITY

REL22 is available in bar (1.1 kg / 2.5 lb), solid feeder wire (diameters of 3.175 mm /.125"), and no clean solder paste (M8 T4 500 gr jar). Other product options are available upon special request.

PHYSICAL PROPERTIES

Parameter	Results	
	REL22	SAC305
Melting Properties	210-212°C with a range of 2 degree	217-220°C with a range of 20 degrees
	undercooling	undercooling
Wetting Time	0.8/sec	0.9/sec
Wetting Force	4.4/mN	4.4/mN
Hardness	29/HV10	14/HV10
Thermal Conductivity	66 W/ m⋅ K	58 W/ m⋅ K
Tensile Strength (aged 150°C for 24 hours)	86 MPa	34 MPa
Microstructure Analysis (aged) 150° for 24 hours	SU3500 20.0kV x2.00k BSE-COMP 20.0µm	SU3500 20.0kV x2.00k BSE-COMP 20.0μm

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HANDLING & STORAGE

Solid wire and bar solder products have a shelf life of 7 years under proper storage conditions. For other product categories, refer to those product specific TDS's. Consult the SDS for specific handling procedures.

SAFETY

Use with adequate ventilation and proper personal protective equipment. Refer to the accompanying Safety Data Sheet for any specific emergency information. Do not dispose of any hazardous materials in non-approved containers.

CLEANING

Refer to data sheets provided by the flux manufacturer.

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